

DIGITAL VIDEO CAMERA CLOCK

ICS421-05

Description

The ICS421-05 is a low-power, low-jitter clock synthesizer developed for digital camera applications. The device accepts a 27 MHz input clock to support common digital video camera interface frequencies including a 12 MHz for USB, 24.576 MHz for IEEE1394, and a 72 MHz CCD clock. Power consumption was minimized by lowering the voltage requirement to 1.8 V minimum.

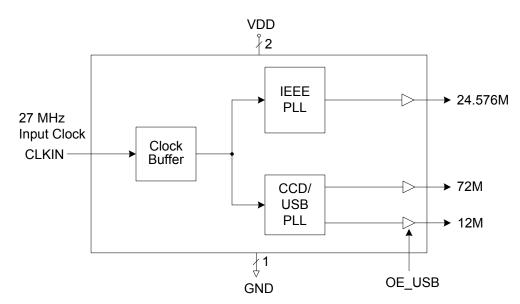
The ICS421-05 utilizes a small form factor 8-pin TSSOP package.

ICS is a leader in low power, consumer application clock sources. Devices are capable of supporting CCD, video, audio, USB, CPU, and other peripherals.

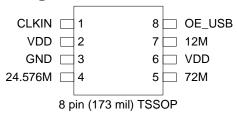
Features

- Ultra-low operating voltage from 1.8 V to 2.4 V
- 10 mA supply current
- 27 MHz input clock frequency
- Fixed 24.576 MHz clock supports IEEE1394
- Fixed 12 MHz clock supports USB
- Fixed 72 MHz CCD clock
- Packaged in 8-pin TSSOP (Pb free)

Block Diagram



Pin Assignment



OE_USB Operation Table

OE_USB	Function
0	Output tri-state
1	Output running

Pin Descriptions

Pin	Pin	Pin	Pin Description
Number	Name	Type	
1	CLKIN	Input	27 MHz single ended clock input.
2	VDD	Power	Connect to voltage supply.
3	GND	Power	Connect to ground.
4	24.576M	Output	24.576 MHz clock output.
5	72M	Output	72 MHz clock output for CCD.
6	VDD	Power	Connect to voltage supply.
7	12M	Output	12 MHz clock output for USB.
8	OE_USB	Input	Output enable for 12M clock for USB. See table for functionality, internal pull-down.

External Components

Series Termination Resistor

Clock output traces over one inch should use series termination. To series terminate a $50\Omega\,trace$ (a commonly used trace impedance), place a $33\Omega\,trace$ resistor in series with the clock line, as close to the clock output pin as possible. The nominal impedance of the clock output is 20Ω

Decoupling Capacitor

As with any high-performance mixed-signal IC, the ICS421-05 must be isolated from system power supply noise to perform optimally.

A decoupling capacitor of $0.01\mu F$ must be connected between VDD and the PCB ground plane.

PCB Layout Recommendations

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

- 1) The $0.01\mu F$ decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible. No vias should be used between decoupling capacitor and VDD pin. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via. Distance of the ferrite bead and bulk decoupling from the device is less critical.
- 2) To minimize EMI, the 33Ω series termination resistor (if needed) should be placed close to the clock output.
- 3) An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers (the ferrite bead and bulk decoupling capacitor can be mounted on the back). Other signal traces should be routed away from the ICS421-05. This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS421-05. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	-0.5 V to 7 V
All Inputs and Outputs	-0.5 V to VDD +0.5 V
Ambient Operating Temperature	0 to +70 ° C
Storage Temperature	-65 to +150 ° C
Junction Temperature	125 ° C
Soldering Temperature	260 ° C

Recommended Operating Conditions

Parameter	Min.	Тур.	Max.	Units
Ambient Operating Temperature	0	_	+70	°C
Power Supply Voltage (measured in respect to GND)	+1.8		+2.4	V

DC Electrical Characteristics

VDD = 1.8 V to 2.4 V, Ambient Temperature 0 to +70° C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Operating Voltage	VDD		1.80		2.40	V
Input High Voltage	V _{IH}	CLKIN	VDD/2+0.5			V
Input Low Voltage	V _{IL}	CLKIN			VDD/2-0.5	V
Input High Voltage	V _{IH}	OE_USB pin	TBD			V
Input Low Voltage	V _{IL}	OE_USB pin			TBD	V
Output High Voltage	V _{OH}	VDD = 2.4 V, I _{OH} = -4 mA	1.9			V
Output Low Voltage	V _{OL}	VDD = 2.4 V, I _{OL} = 4 mA			0.4	V
Output High Voltage	V _{OH}	VDD = 1.8 V I _{OH} = -4 mA	1.4			V
Output Low Voltage	V _{OL}	VDD = 1.8 V I _{OL} = 4 mA			0.4	V
Operating Supply Current	IDD	No load, 3 out		10		mA

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Short Circuit Current	I _{OS}	Each output		50		mA
Nominal Output Impedance	Z _o			20		W
On-chip Pull-down Resistor		OE_USB		150		kΩ

Notes: 1. Nominal switching threshold is VDD/2

AC Electrical Characteristics

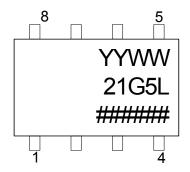
VDD = **1.8 V to 2.4 V**, Ambient Temperature 0 to +70° C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Input Frequency		Clock Input		27		MHz
Output Rise Time	t _{OR}	VDD=2.4 V, 20% to 80%, C _L =10 pF		1.8		ns
Output Fall Time	t _{OF}	VDD=2.4 V, 80% to 20%, C _L =10 pF		1.8		ns
Output Rise Time	t _{OR}	VDD=1.8 V, 20% to 80%, C _L =10 pF		2.5		ns
Output Fall Time	t _{OF}	VDD=1.8 V, 80% to 20%, C _L =10 pF		2.5		ns
Output Clock Duty Cycle		at VDD/2		50		%
Absolute Pk-Pk Jitter		72 MHz output clock		±200		ps
PLL Lock Time within 1%		Power OFF to lock			10	ms

Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	θ_{JA}	Still air		110		° C/W
Ambient	θ_{JA}	1 m/s air flow		100		° C/W
	θ_{JA}	3 m/s air flow		80		° C/W
Thermal Resistance Junction to Case	θ_{JC}			35		° C/W

Marking Diagram

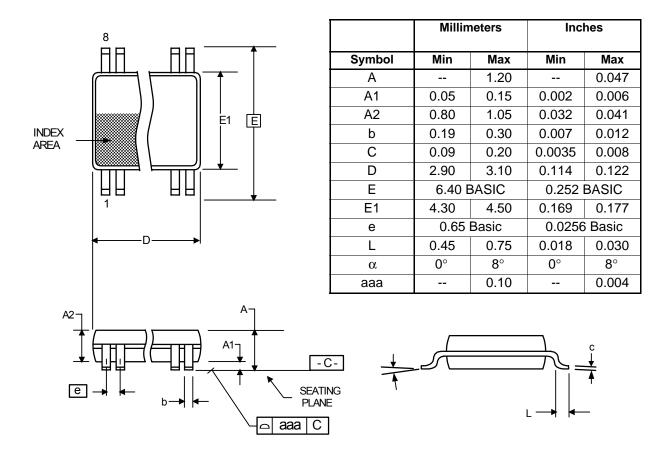


Notes:

- 1. ##### is the lot code.
- 2. YYWW is the last two digits of the year, and the week number that the part was assembled.
- 3. "L" designates Pb (lead) free package.

Package Outline and Package Dimensions (8-pin TSSOP, 173 Mil. Body)

Package dimensions are kept current with JEDEC Publication No. 95



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
421G-05LF	21G5L	Tubes	8-pin TSSOP	0 to +70 ° C
421G-05LFT	2100L	Tape & Reel	8-pin TSSOP	0 to +70 ° C

[&]quot;LF" denotes Pb (lead) free package.

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For Sales

800-345-7015 408-284-8200 Fax: 408-284-2775

For Tech Support

oduct line email>

Corporate Headquarters

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road San Jose, CA 95138 United States 800 345 7015 +408 284 8200 (outside U.S.)

Asia Pacific and Japan

Integrated Device Technology Singapore (1997) Pte. Ltd. Reg. No. 199707558G 435 Orchard Road #20-03 Wisma Atria Singapore 238877 +65 6 887 5505

Europe

IDT Europe, Limited Prime House Barnett Wood Lane Leatherhead, Surrey United Kingdom KT22 7DE +44 1372 363 339



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